

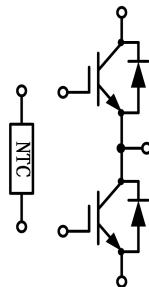
Half Bridge IGBT Module

电气特性:

- 1200V 沟槽栅/场终止工艺
1200V Trench with Field Stop technology
- 低开关损耗
Low switching losses
- 正温度系数
V_{CESat} with positive temperature coefficient

典型应用:

- UPS 系统
UPS system
 - 伺服驱动器
Servo drives
 - 大功率变流器
High Power Converters
 - 电机传动
Motor drives
- $V_{CES} = 1200V$, $I_{C\text{ nom}} = 900A$ / $I_{CRM} = 1800A$



IGBT, 逆变器 / IGBT, Inverter

最大额定值 / Maximum Ratings

Parameter	Conditions	Symbol	Value	Unit
集电极-发射极电压 Collector-Emitter voltage	$T_{vj}=25^\circ C$	V_{CES}	1200	V
连续集电极直流电流 Continuous DC collector current	$T_C=90^\circ C$, $T_{vj\text{ max}}=175^\circ C$	$I_{C\text{ nom}}$	900	A
集电极重复峰值电流 Repetitive peak collector current	$t_p = 1ms$	I_{CRM}	1800	A
总功率损耗 Total power dissipation	$T_C = 25^\circ C$, $T_{vj\text{ max}} = 175^\circ C$	P_{tot}	3600	W
栅极-发射极电压 Gate emitter voltage		V_{GE}	± 20	V

特征值 / Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
集电极-发射极饱和电压 Collector-Emitter saturation voltage	V _{GE} =15V, I _c =900A V _{GE} =15V, I _c =900A V _{GE} =15V, I _c =900A	T _{vj} =25°C T _{vj} =125°C T _{vj} =175°C	V _{CES} sat	1.65	2.10	V
栅极-发射极阈值电压 Gate-Emitter threshold voltage	I _c =18mA, V _{GE} = V _{CE} ,	T _{vj} =25°C		1.95	2.10	
栅电荷 Gate charge	V _{GE} =-15V...+15V			5.2	5.8	6.4
内部栅极电阻 Internal gate resistor	T _{vj} =25°C	R _{Gint}		11.5		μC
输入电容 Input capacitance	f=100KHz, V _{CE} =25V, V _{GE} =0 V	T _{vj} =25°C	C _{ies}	140		nF
反向传输电容 Reverse transfer capacitance			C _{res}	0.55		
集电极-发射极截止电流 Collector-emitter cut-off current	V _{CE} =1200V , V _{GE} = 0 V	T _{vj} =25°C	I _{CES}		0.1	mA
栅极-发射极漏电流 Gate-emitter leakage current	V _{CE} =0 V, V _{GE} = 20 V	T _{vj} =25°C	I _{GES}		100	nA
开通延迟时间 Turn-on delay time	I _c =900A, V _{CE} =600V V _{GE} =±15V, R _G =0.5Ω (电感负载) / (inductive load)	T _{vj} =25°C T _{vj} =125°C T _{vj} =175°C	t _{d on}	409		
上升时间 Rise time	I _c =900A, V _{CE} =600V V _{GE} =±15V, R _G =0.5Ω (电感负载) / (inductive load)	T _{vj} =25°C T _{vj} =125°C T _{vj} =175°C		435		
关断延迟时间 Turn-off delay time	I _c =900A, V _{CE} =600V V _{GE} =±15V, R _G =0.5Ω (电感负载) / (inductive load)	T _{vj} =25°C T _{vj} =125°C T _{vj} =175°C		445		
下降时间 Fall time	I _c =900A, V _{CE} =600V V _{GE} =±15V, R _G =0.5Ω (电感负载) / (inductive load)	T _{vj} =25°C T _{vj} =125°C T _{vj} =175°C	t _f	75		ns
开通损耗能量 (每脉冲) Turn-on energy loss per pulse	I _c =900A, V _{CE} =600V di/dt=7500A/us(Tvj=175°C) V _{GE} =±15V, R _G =0.5Ω	T _{vj} =25°C T _{vj} =125°C T _{vj} =175°C	E _{on}	510		
关断损耗能量 (每脉冲) Turn-off energy loss per pulse	I _c =900A, V _{CE} =600V dv/dt=3100V/us(Tvj=175°C) V _{GE} =±15V, R _G =0.5Ω	T _{vj} =25°C T _{vj} =125°C T _{vj} =175°C		575		
短路数据 SC data	V _{GE} ≤15V, V _{cc} =800V V _{CEmax} =V _{CES} -L _{sCE} ·di/dt	t _p ≤8us, T _{vj} =150°C t _p ≤6us, T _{vj} =175°C		620		
结-外壳热阻 Thermal resistance, junction to case	每个 IGBT / per IGBT		R _{thJC}		0.044	K/W
在开关状态下温度 Temperature under switching conditions	T _{vj op} > 150 °C is only allowed for operation at overload conditions.		T _{vj op}	-40	175	°C

二极管, 逆变器 / Diode, Inverter**最大额定值 / Maximum Ratings**

Parameter	Conditions	Symbol	Value	Unit
反向重复峰值电压 Repetitive peak reverse voltage	$T_{vj}=25^{\circ}\text{C}$	V_{RRM}	1200	V
连续正向直流电流 Continuous DC forward current		I_F	900	A
正向重复峰值电流 Repetitive peak forward current	$t_p=1\text{ms}$	I_{FRM}	1800	A
I^2t 值 I^2t -value	$t_p=10\text{ms}, \sin 180^{\circ}, T_j=125^{\circ}\text{C}$	I^2t	30000	A^2s

特征值 / Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
正向电压 Forward voltage	$I_F=900\text{A}, V_{GE}=0\text{V}$	V_F		2.05	2.35	V
	$I_F=900\text{A}, V_{GE}=0\text{V}$			2.25		
	$I_F=900\text{A}, V_{GE}=0\text{V}$			2.25		
反向恢复峰值电流 Peak reverse recovery current	$I_F=900\text{A}$	I_{RM}		512		A
	$-di_F/dt=7500\text{A}/\mu\text{s}$ ($T_{vj}=175^{\circ}\text{C}$)			544		
	$V_R=600\text{V}, V_{GE}=-15\text{V}$			556		
恢复电荷 Recovered charge	$I_F=900\text{A}$	Q_r		85		μC
	$-di_F/dt=7500\text{A}/\mu\text{s}$ ($T_{vj}=175^{\circ}\text{C}$)			148		
	$V_R=600\text{V}, V_{GE}=-15\text{V}$			189		
反向恢复损耗 (每脉冲) Reverse recovered energy	$I_F=900\text{A}$	E_{rec}		42		mJ
	$-di_F/dt=7500\text{A}/\mu\text{s}$ ($T_{vj}=175^{\circ}\text{C}$)			68		
	$V_R=600\text{V}, V_{GE}=-15\text{V}$			83		
结-外壳热阻 Thermal resistance, junction to case	每个 Diode / per diode	R_{thJC}			0.069	K/W
在开关状态下温度 Temperature under switching conditions	$T_{vj\ op} > 150^{\circ}\text{C}$ is only for operation at overload conditions.	$T_{vj\ op}$	-40		175	$^{\circ}\text{C}$

负温度系数热敏电阻 / NTC-Thermistor**特征值 / Characteristic Values**

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
额定电阻值 Rated resistances	T _c =25°C, ±3%	R ₂₅		5.0		KΩ
B-值 B-value	R ₂ = R ₂₅ exp[B _{25/50} (1/T ₂ - 1/(298,15 K))]	B _{25/50}		3375		K
B-值 B-value	R ₂ = R ₂₅ exp[B _{25/80} (1/T ₂ - 1/(298,15 K))]	B _{25/80}		3425		K
B-值 B-value	R ₂ = R ₂₅ exp[B _{25/100} (1/T ₂ - 1/(298,15 K))]	B _{25/100}		3443		K

模块 / Module

Parameter	Conditions	Symbol	Value			Unit
绝缘测试电压 Isolation test voltage	RMS, f=50Hz, t=1min	V _{ISOL}	3400			V
内部绝缘 Internal isolation	基本绝缘 (class 1, IEC 61140) basic insulation (class 1, IEC 61140)		Al ₂ O ₃			
相对电痕指数 Comperative tracking index		CTI	>200			
相对温度指数(电) RTI Elec.	housing	RTI	140			°C
杂散电感, 模块 Stray inductance module		L _{sCE}		20		nH
储存温度 Storage temperature		T _{stg}	-40		125	°C
模块安装的扭矩 Mounting torque for module mounting		M	3.0		6.0	Nm
端子连接扭矩 Terminal Connection Torque		M	3.0		6.0	Nm
重量 Weight		W		357		g

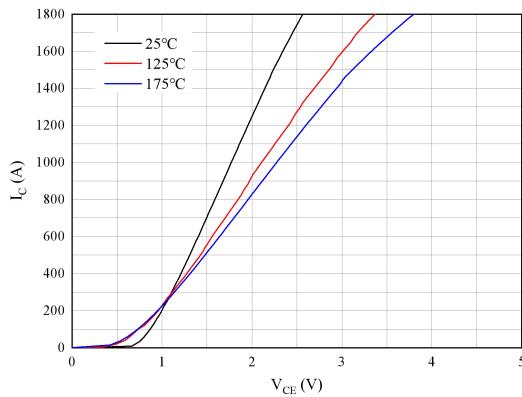
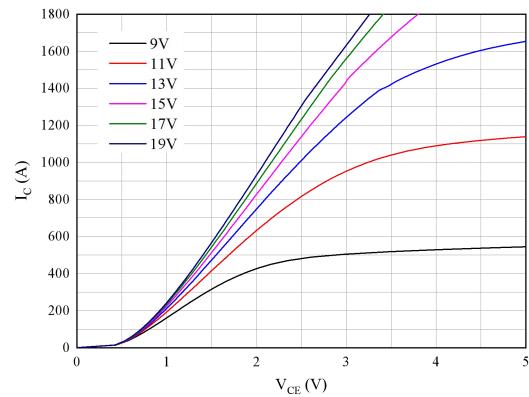
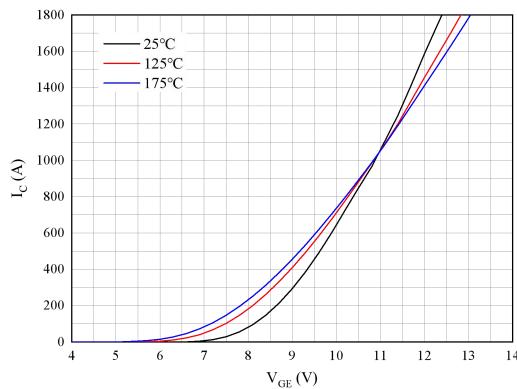
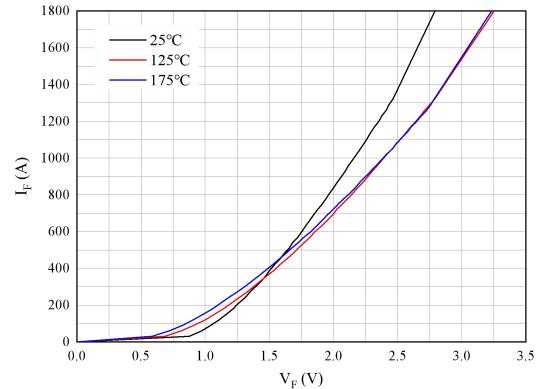
图 1. 典型输出特性 ($V_{GE}=15V$)Figure 1. Typical output characteristics ($V_{GE}=15V$)图 2. 典型输出特性 ($T_{vj}=175^{\circ}C$)Figure 2. Typical output characteristics ($T_{vj}=175^{\circ}C$)图 3. 典型传输特性($V_{CE}=20V$)Figure 3. Typical transfer characteristic ($V_{CE}=20V$)

图 4. 正向偏压特性 二极管

Figure 4. Forward characteristic of Diode

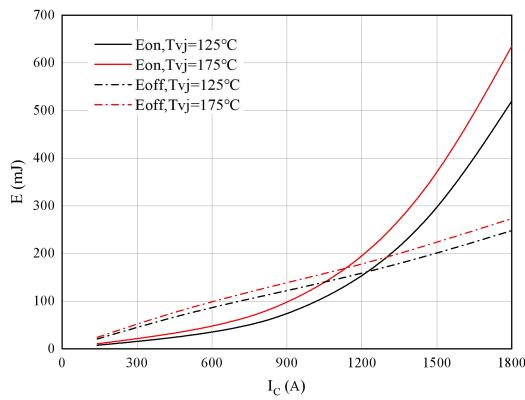


图 5. 开关损耗 逆变器

Figure 5. Switching losses of IGBT

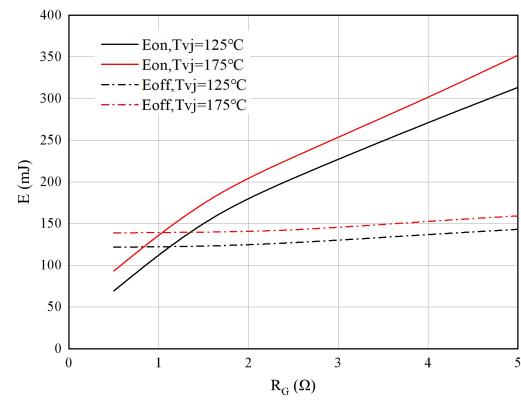
 $V_{GE}=\pm 15V$, $R_{Gon}=0.5\Omega$, $R_{Goff}=0.5\Omega$, $V_{CE}=600V$ 

图 6. 开关损耗 逆变器

Figure 6. Switching losses of IGBT

 $V_{GE}=\pm 15V$, $I_C=900A$, $V_{CE}=600V$

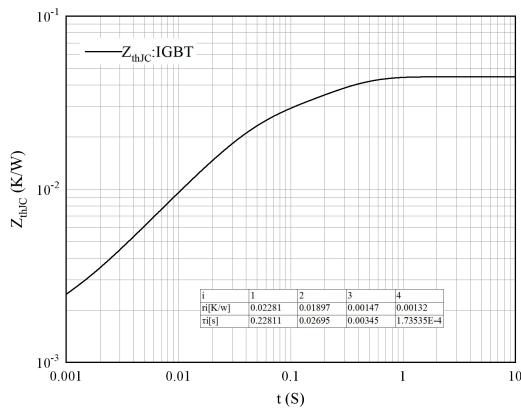


图 7. 瞬态热阻抗 IGBT 逆变器

Figure 7. Transient thermal impedance IGBT, Inverter

$Z_{thJC}=f(t)$

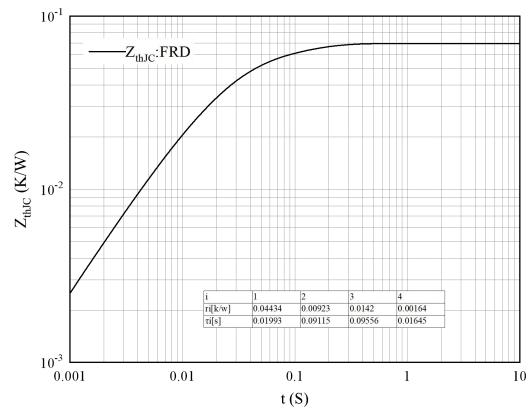


图 8. 瞬态热阻抗 FRD 逆变器

Figure 8. Transient thermal impedance FRD, Inverter

$Z_{thJC}=f(t)$

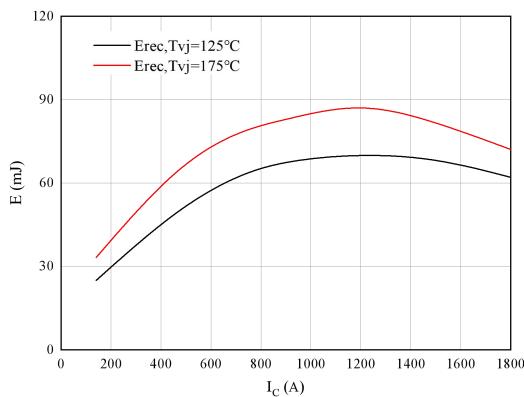


图 9. 开关损耗 二极管

Figure 9. Switching losses of Diode

$R_{Gon}=0.5\Omega, V_{CE}=600V$

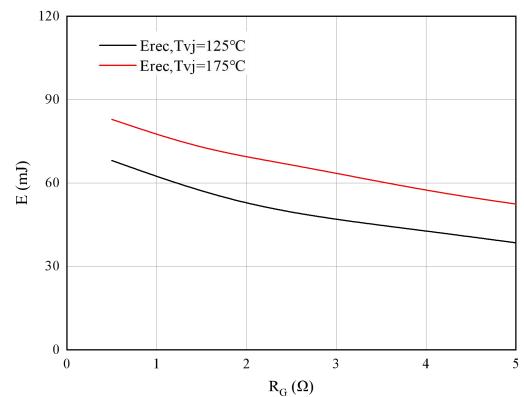


图 10. 开关损耗 二极管

Figure 10. Switching losses of Diode

$IF=900A, V_{CE}=600V$

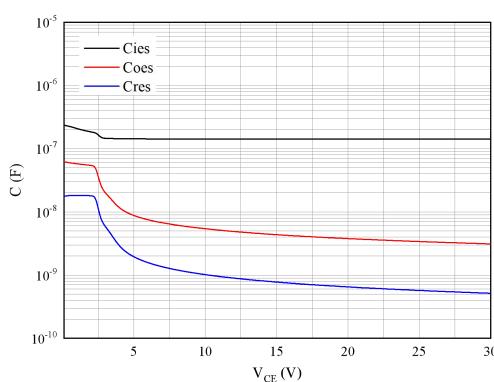


图 11. 电容特性

Figure 11. Capacitance characteristic

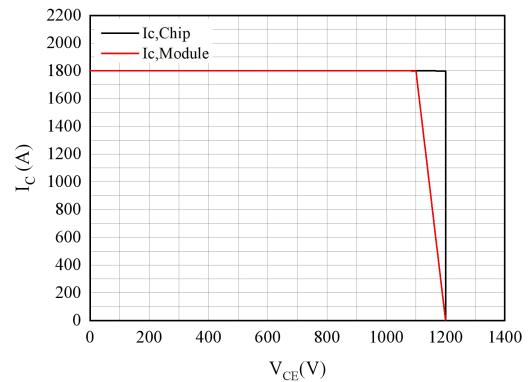


图 12. 反偏安全工作区

Figure 12. RBSOA

$V_{GE}=\pm 15V, RGoff=0.5\Omega, T_{vj}=175^\circ C$

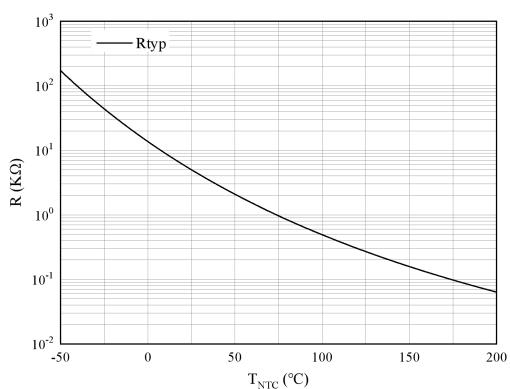
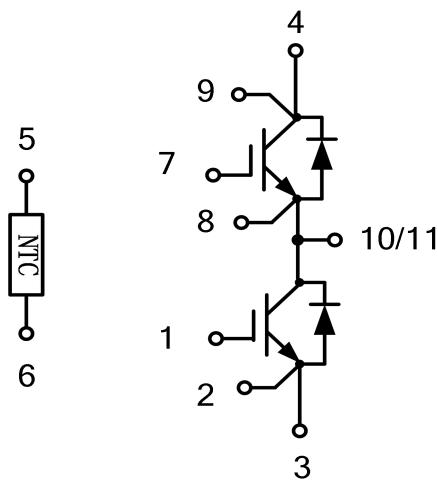


图 13. 负温系数热敏电阻 温度特性

Figure13. NTC-Thermistor-temperature characteristic

接线图 / Circuit diagram



封装尺寸 / Package outlines

